



FAST CMOS 18-BIT REGISTERED TRANSCEIVER

IDT74FCT162501AT/CT

FEATURES:

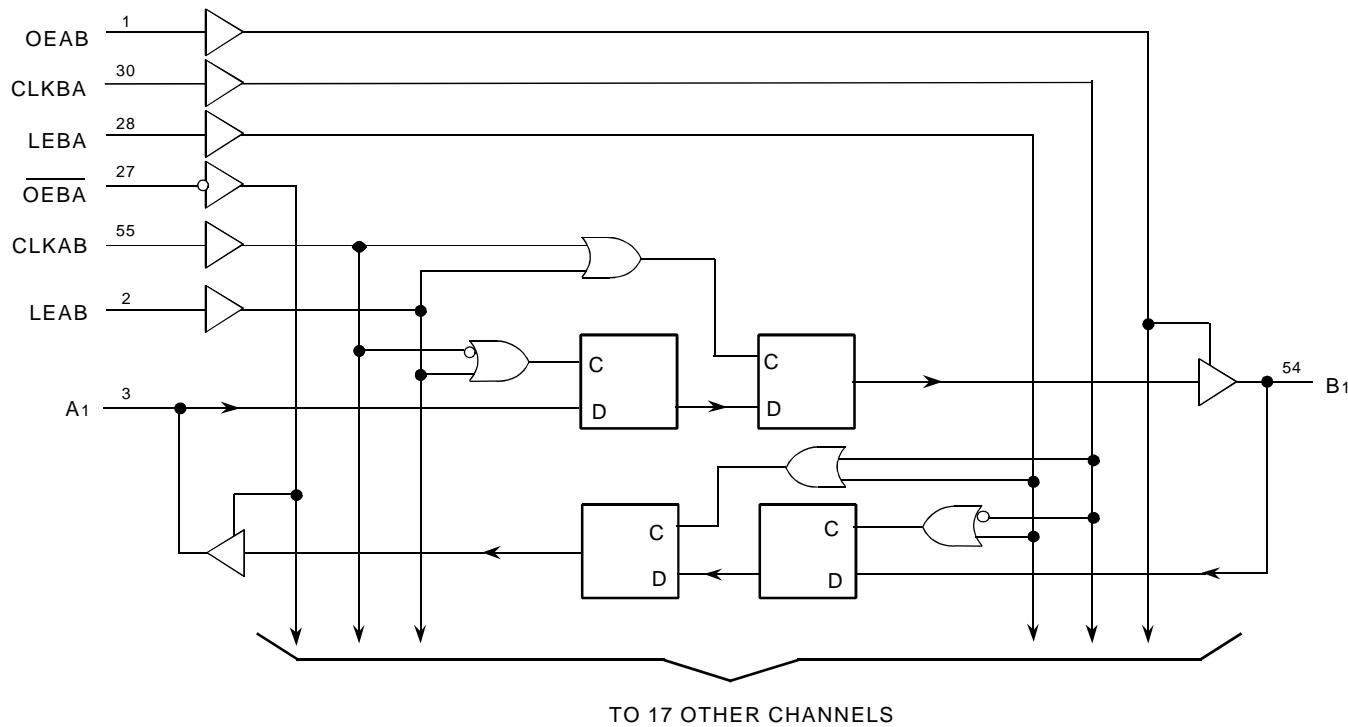
- 0.5 MICRON CMOS Technology
- High-speed, low-power CMOS replacement for ABT functions
- Typical $t_{sk(o)}$ (Output Skew) < 250ps
- Low input and output leakage $\leq 1\mu A$ (max.)
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model ($C = 200pF$, $R = 0$)
- Balanced Output Drivers ($\pm 24mA$)
- Reduced system switching noise
- Typical V_{OLP} (Output Ground Bounce) < 0.6V at $V_{CC} = 5V$, $TA = 25^\circ C$
- Available in SSOP, TSSOP, and TVSOP packages

DESCRIPTION:

The FCT162501T 18-bit registered transceivers are built using advanced dual metal CMOS technology. These high-speed, low-power 18-bit registered bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched and clocked modes. Data flow in each direction is controlled by output-enable (OEAB and \overline{OEBA}), latch enable (LEAB and LEBA) and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A bus data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. OEAB is the output enable for the B port. Data flow from the B port to the A port is similar but requires using \overline{OEBA} , LEBA and CLKBA. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

The FCT162501T has balanced output drive with current limiting resistors. This offers low ground bounce, minimal undershoot, and controlled output fall times—reducing the need for external series terminating resistors. The FCT162501T is a plug-in replacement for the FCT16501T and ABT16501 for on-board bus interface applications.

FUNCTIONAL BLOCK DIAGRAM

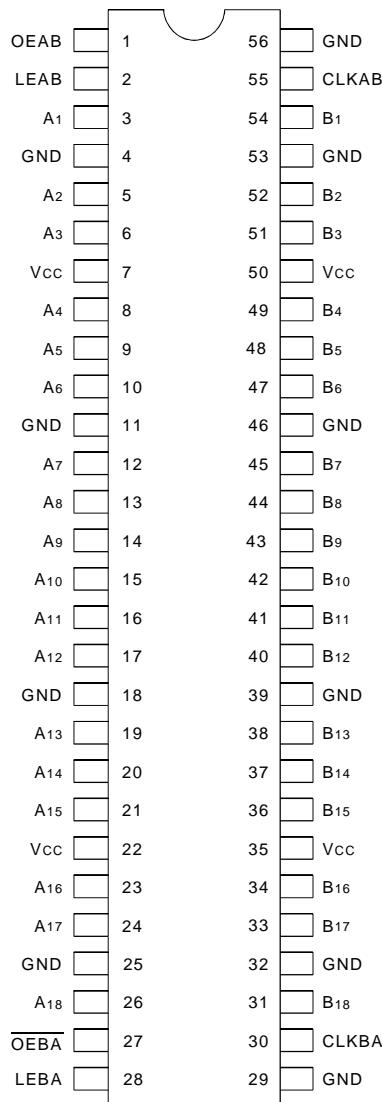


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INDUSTRIAL TEMPERATURE RANGE

JANUARY 2002

PIN CONFIGURATION



SSOP/ TSSOP/ TVSOP
TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to 7	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to V _{CC} +0.5	V
TSTG	Storage Temperature	-65 to +150	°C
I _{OUT}	DC Output Current	-60 to +120	mA

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- All device terminals except FCT162XXX Output and I/O terminals.
- Output and I/O terminals for FCT162XXX.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	3.5	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	3.5	8	pF

NOTE:

- This parameter is measured at characterization but not tested.

FUNCTION TABLE^(1,4)

Inputs				Outputs
OEAB	LEAB	CLKAB	A _x	B _x
L	X	X	X	Z
H	H	X	L	L
H	H	X	H	H
H	L	↑	L	L
H	L	↑	H	H
H	L	L	X	B ⁽²⁾
H	L	H	X	B ⁽³⁾

NOTES:

- A-to-B data flow is shown. B-to-A data flow is similar but uses \overline{OEBA} , \overline{LEBA} , and \overline{CLKBA} .
- Output level before the indicated steady-state input conditions were established.
- Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.
- H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
Z = High-impedance
↑ = LOW-to-HIGH Transition

PIN DESCRIPTION

Pin Names	Description
OEAB	A-to-B Output Enable Input
\overline{OEBA}	B-to-A Output Enable Input (Active LOW)
LEAB	A-to-B Latch Enable Input
LEBA	B-to-A Latch Enable Input
CLKAB	A-to-B Clock Input
CLKBA	B-to-A Clock Input
A _x	A-to-B Data Inputs or B-to-A 3-State Outputs
B _x	B-to-A Data Inputs or A-to-B 3-State Outputs

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
ΔI_{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V _{CC} = Max. V _{IN} = 3.4V ⁽³⁾		—	0.5	1.5	mA
I _{CCD}	Dynamic Power Supply Current ⁽⁴⁾	V _{CC} = Max. Outputs Open OEAB = <u>OEBA</u> = V _{CC} or GND One Input Toggling 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND	—	75	120	μ A/ MHz
I _C	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max. Outputs Open f _{CP} = 10MHz (CLKAB) 50% Duty Cycle OEAB = <u>OEBA</u> = V _{CC}	V _{IN} = V _{CC} V _{IN} = GND	—	0.8	1.7	mA
		LEAB = GND One Bit Toggling f _i = 5MHz 50% Duty Cycle	V _{IN} = 3.4V V _{IN} = GND	—	1.3	3.2	
		V _{CC} = Max. Outputs Open f _{CP} = 10MHz (CLKAB) 50% Duty Cycle OEAB = <u>OEBA</u> = V _{CC}	V _{IN} = V _{CC} V _{IN} = GND	—	3.8	6.5 ⁽⁵⁾	
		LEAB = GND Eighteen Bit Toggling f _i = 2.5MHz 50% Duty Cycle	V _{IN} = 3.4V V _{IN} = GND	—	8.5	20.8 ⁽⁵⁾	

NOTES:

1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at V_{CC} = 5.0V, +25°C ambient.

3. Per TTL driven input (V_{IN} = 3.4V). All other inputs at V_{CC} or GND.

4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.

5. Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.

6. I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}

$$I_C = I_{CC} + \Delta I_{CC} D_{HNT} + I_{CCD} (f_{CP} N_{CP}/2 + f_i N_i)$$

I_{CC} = Quiescent Current (I_{CC1}, I_{CC2} and I_{CC3})

ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V).

D_H = Duty Cycle for TTL Inputs High

N_T = Number of TTL Inputs at D_H

I_{CCD} = Dynamic Current caused by an Input Transition Pair (HLH or LHL)

f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)

N_{CP} = Number of Clock Inputs at f_{CP}

f_i = Input Frequency

N_i = Number of Inputs at f_i

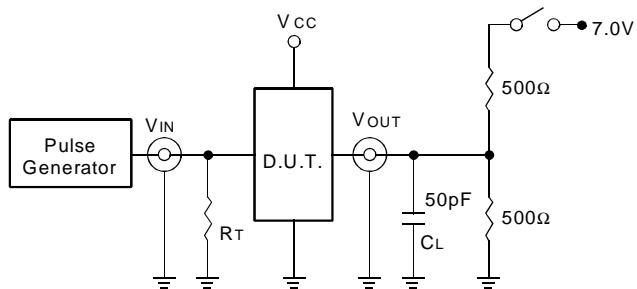
SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	Condition ⁽¹⁾	74FCT162501AT		74FCT162501CT		Unit
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	
f _{MAX}	CLKAB or CLKBA frequency ⁽⁴⁾	CL = 50pF RL = 500Ω	—	150	—	150	MHz
t _{PLH}	Propagation Delay Ax to Bx or Bx to Ax		1.5	5.1	1.5	4.3	ns
t _{PHL}	Propagation Delay LEBA to Ax, LEAB to Bx		1.5	5.6	1.5	4.4	ns
t _{PLH}	Propagation Delay CLKBA to Ax, CLKAB to Bx		1.5	5.6	1.5	4.4	ns
t _{PZH}	Output Enable Time OEBA to Ax, OEAB to Bx		1.5	6	1.5	4.8	ns
t _{PLZ}	Output Disable Time OEBA to Ax, OEAB to Bx		1.5	5.6	1.5	5.2	ns
t _{SU}	Set-up Time, HIGH or LOW Ax to CLKAB, Bx to CLKBA		3	—	2.4	—	ns
t _H	Hold Time, HIGH or LOW Ax to CLKAB, Bx to CLKBA		0	—	0	—	ns
t _{SU}	Set-up Time, HIGH or LOW Ax to LEAB, Bx to LEBA	Clock LOW Clock HIGH	3	—	2	—	ns
t _H	Hold Time, HIGH or LOW Ax to LEAB, Bx to LEBA		1.5	—	1.5	—	ns
t _W	LEAB or LEBA Pulse Width HIGH ⁽⁴⁾		1.5	—	0.5	—	ns
t _W	CLKAB or CLKBA Pulse Width HIGH or LOW ⁽⁴⁾		3	—	3	—	ns
t _{SK(0)}	Output Skew ⁽³⁾		—	0.5	—	0.5	ns

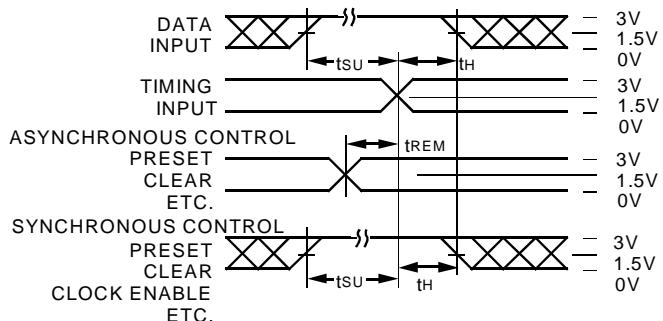
NOTES:

1. See test circuits and waveforms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
4. This parameter is guaranteed but not tested.

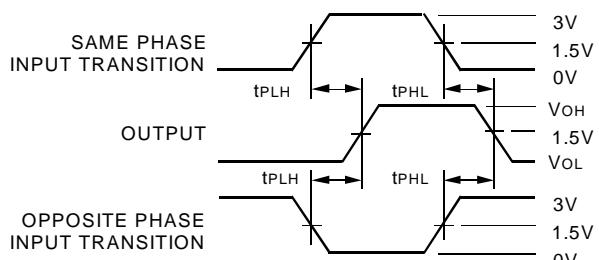
TEST CIRCUITS AND WAVEFORMS



Test Circuits For all Outputs



Set-up, Hold, and Release Times



Propagation Delay

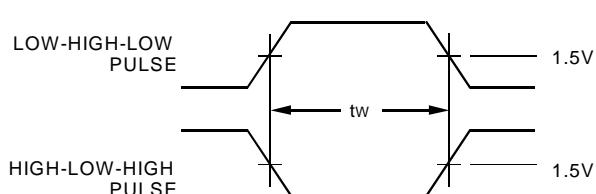
SWITCH POSITION

Test	Switch
Open Drain	Closed
Disable Low	
Enable Low	
All Other Tests	Open

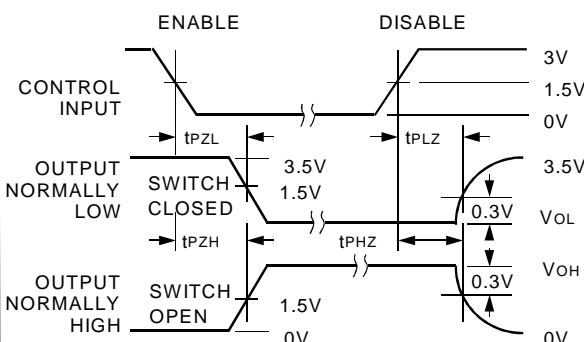
DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.



Pulse Width

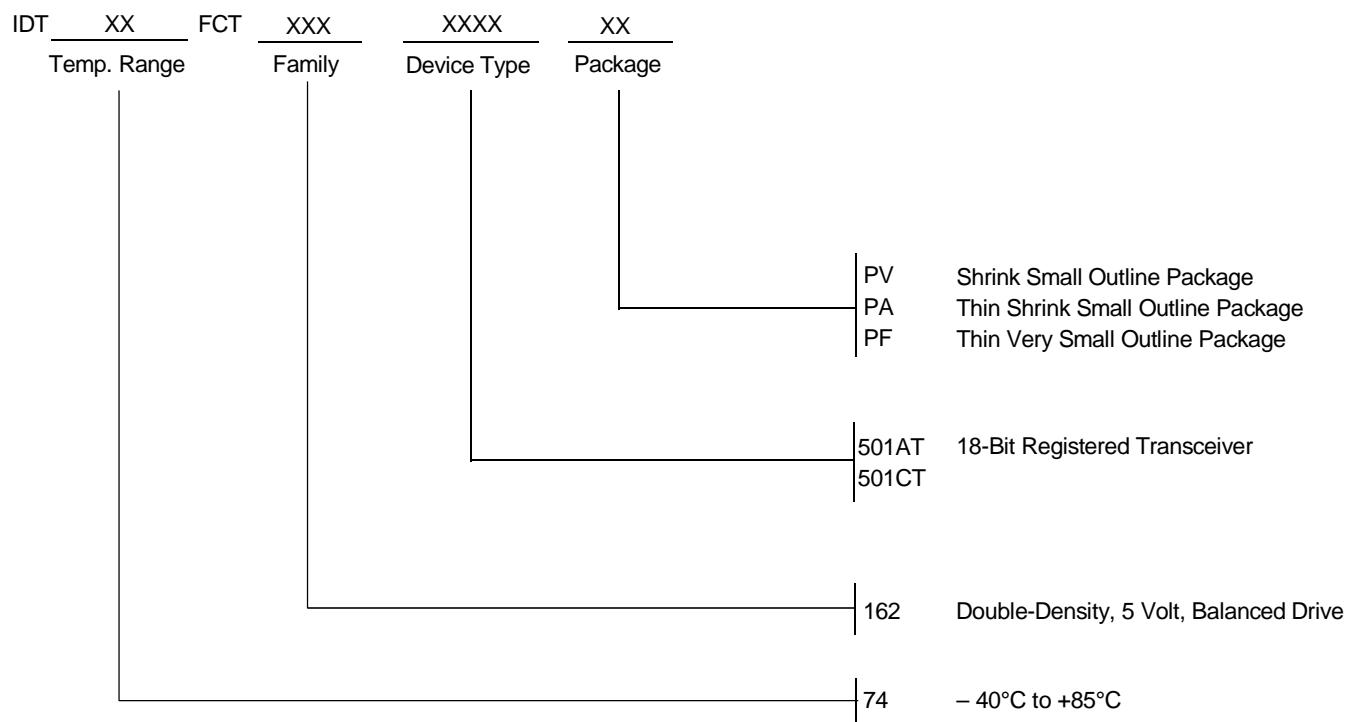


Enable and Disable Times

NOTES:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
2. Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $t_f \leq 2.5\text{ns}$; $t_r \leq 2.5\text{ns}$.

ORDERING INFORMATION



DATA SHEET DOCUMENT HISTORY

1/21/2002

Removed Military temp grade



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